

Electronic Patent Application Fee Transmittal

Application Number:	10628198			
Filing Date:	28-Jul-2003			
Title of Invention:	Two step semiconductor manufacturing process for copper interconnects			
First Named Inventor:	Young-Joon Park			
Filer:	Rose Alyssa Keagy			
Attorney Docket Number:	TI-35623			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	500	500
Filing a brief in support of an appeal	1402	1	500	500
Post-Allowance-and-Post-Issuance:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1000